



Product Change Notification

111784 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111784 - 00
Change Title: Intel® Server System SR1601GPLX and SR1602GPLX
PCN 111784-00, Product Design
Update eUSB Device and Rear Panel Design
Date of Publication: December 07, 2012

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Dec 24, 2012
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Description of Change to the Customer:

For Intel® Server System SR1601GPLX:

1. Update the eUSB connector to increase the retention strength of the module.

For Intel® Server System SR1602GPLX:

1. Update the eUSB connector to increase the retention strength of the module.
2. Update the rear panel design as follows:
 - a) Basepan changes (G20110-002 to -003) to support the Intel® Server Board S2400EP Power Supply (PSU). Adding through hole to fit new PSU bracket. Removing two rail mounting studs to support the Premium rail. Changing the PSU bracket mounting stud location to the PSU cage. PSU will move 2.35mm to the front end side.
 - b) Rear Panel change (G19605-002 to -003) to support new PSU location. Change rear panel to fit new PSU cage and PSU mounting location.
 - c) Rack Handle (G20811-002 to -003) Update to the latest design. Rack handle is a common part. Using a longer thumb screw to fit with Premium rail.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers, no action recommended or required.

Products Affected / Intel Ordering Codes:

Core SKUs			
Product Code	MM#	Pre Change TA	Post Change TA
SR1602GPLX	911153	G21305-004	G21305-005
SR1601GPLX	916656	G14584-004	G14584-005

PCN Revision History:

Date of Revision:

December 7, 2012

Revision Number:

00

Reason:

Originally Published PCN